

Application No.:
10/523,494

Attorney Docket No.:
Chelix-0008USAAACN37

REMARKS

Applicants wish to thank the Examiner for the attention accorded to the instant application. In response to the office action mailed on September 20, 2006, Applicants have amended claims 2 and 3 and present the below remarks related to claims 2, 3 and 5.

Claim 2 is amended to overcome the rejection under 35 USC §112, second paragraph.

Claims 2 and 3 stand rejected under 35 USC §102(b) as being anticipated by An et al. U.S. Patent No. 5851411. Notably, An et al. discloses that the LCD panel substrates are formed, and a hole is provided at the edge for injecting liquid crystal material.

However, the method of claim 2 does not involve injection between substrates. Instead, in the method of claim 2 is for cutting flexible glazing structures by applying a non-conductive barrier material to a first of a pair of substrates to be laminated before coating with liquid crystal material. Then, the substrates are laminated with liquid crystal material therebetween. Cutting is then accomplished along a barrier formed by the non-conductive barrier material. This method is not disclosed in An et al.

Further, claim 3 is directed to a method to expose electrical contacts in flexible glazing structures. Notches are cut in both of a pair of substrates to be laminated, and the substrates are registered such that the notches do not overlap when the substrates are laminated together. Further, the notches allow the inner surfaces of the substrates to be exposed. In contrast, the notches described in An et al. do not expose the inner surfaces of the substrate, and further, the notches are indeed aligned in contrast to claim 3, and that is their purpose - to facilitate cutting - rather than to expose conductors as in claim 3.

Finally, regarding claim 5, which stands rejected under 35 USC §103(a) as being unpatentable over An et al. in view of Choi et al. U.S. Patent No. 6876430, it is respectfully

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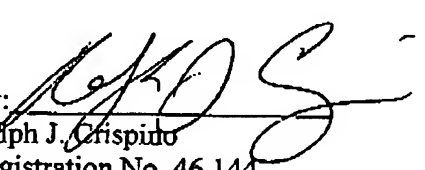
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submitted that the combination does not teach or suggest the method for cutting a flexible glazing structure as presented in claim 5. The purpose of lowering the temperature in the background description of Choi referred to by the Examiner deals with temperature lowering for the purposes of aligning, not for cutting to prevent the substrates from contacting one another due to the high viscosity. Further, An et al. does not deal with laminating substrates, but rather with injection of liquid crystal material through a hole in the edge of the LCD panel.

Applicants thank the Examiner for indication of allowance of claims 6, 8 and 9. Further, while the Examiner indicates that claim 2 would be allowable in the office action, Applicants believe that the Examiner actually was referring to claim 4, which depends from claim 2, and is marked as "objected to" in the PTOL-326 form. Please contact the undersigned if this is incorrect.

No new matter is presented herein. Favorable action is earnestly solicited. The Examiner is invited contact the undersigned by telephone to discuss any matters that may place the application in condition for allowance.

Respectfully submitted,

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